

Smart Highside Power Switch

Features

- Load dump and reverse battery protection¹⁾
- Clamp of negative voltage at output
- Short-circuit protection
- Current limitation
- Thermal shutdown
- Diagnostic feedback
- Open load detection in ON-state
- CMOS compatible input
- **Electrostatic discharge (ESD)** protection
- Loss of ground and loss of V_{bb} protection²⁾
- Overvoltage protection
- Undervoltage and overvoltage shutdown with auto-restart and hysteresis

Application

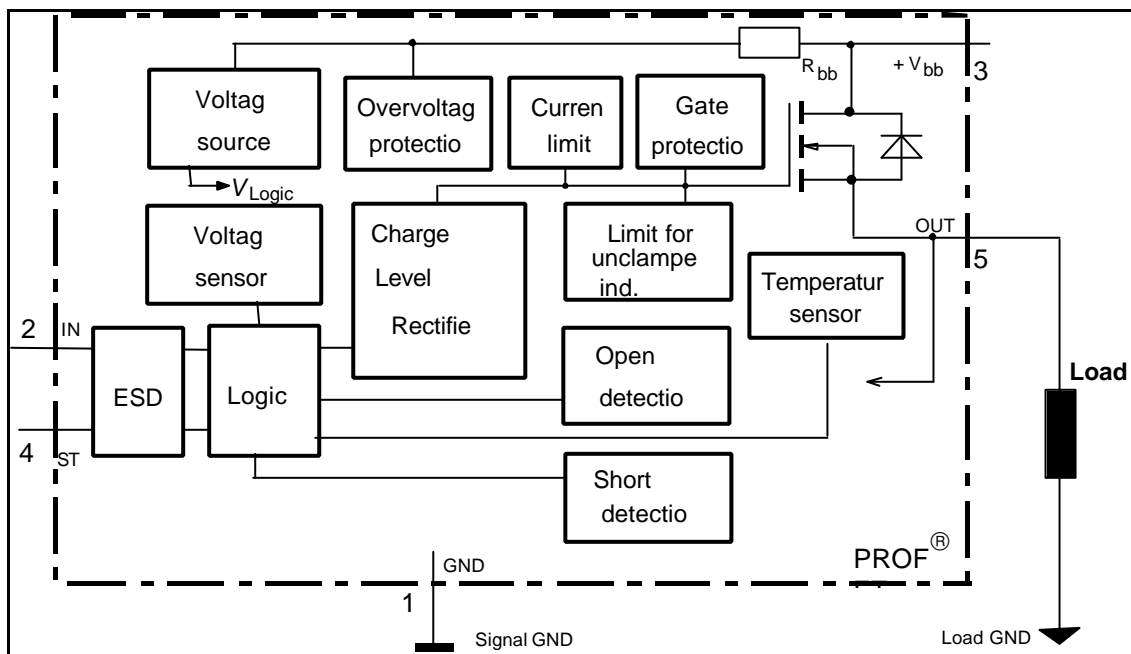
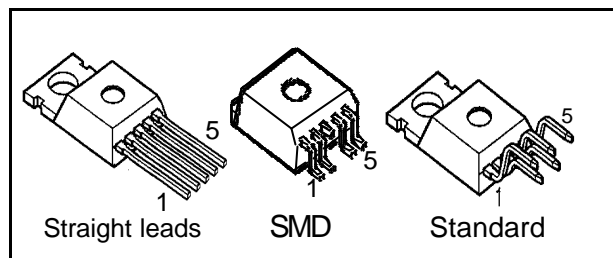
- μ C compatible power switch with diagnostic feedback for 12 V and 24 V DC grounded loads
- All types of resistive, inductive and capacitive loads
- Replaces electromechanical relays and discrete circuits

General Description

N channel vertical power FET with charge pump, ground referenced CMOS compatible input and diagnostic feedback, integrated in Smart SIPMOS® chip on chip technology. Fully protected by embedded protection functions.

Product Summary

$V_{Load\ dump}$	80	V
$V_{bb} - V_{OUT}$ Avalanche Clamp	58	V
V_{bb} (operation)	4.5 ... 42	V
V_{bb} (reverse)	-32	V
R_{ON}	38	m Ω
$I_L(SCp)$	44	A
$I_L(SCr)$	35	A
$I_L(ISO)$	11	A



1) No external components required, reverse load current limited by connected load.

2) Additional external diode required for charged inductive loads

Pin	Symbol		Function
1	GND	-	Logic ground
2	IN	I	Input, activates the power switch in case of logical high signal
3	V _{bb}	+	Positive power supply voltage, the tab is shorted to this pin
4	ST	S	Diagnostic feedback, low on failure
5	OUT (Load, L)	O	Output to the load

Maximum Ratings at $T_j = 25\text{ °C}$ unless otherwise specified

Parameter	Symbol	Values	Unit	
Supply voltage (overvoltage protection see page 3)	V_{bb}	63	V	
Load dump protection $V_{LoadDump} = U_A + V_S$, $U_A = 13.5\text{ V}$ $R_I = 2\ \Omega$, $R_L = 1.1\ \Omega$, $t_d = 200\text{ ms}$, IN= low or high	$V_S^{3)}$	66.5	V	
Load current (Short-circuit current, see page 4)	I_L	self-limited	A	
Operating temperature range	T_j	-40 ... +150	°C	
Storage temperature range	T_{stg}	-55 ... +150		
Power dissipation (DC)	P_{tot}	125	W	
Inductive load switch-off energy dissipation, single pulse $T_j = 150\text{ °C}$:	E_{AS}	1.7	J	
Electrostatic discharge capability (ESD) (Human Body Model)	V_{ESD}	2.0	kV	
Input voltage (DC)	V_{IN}	-0.5 ... +6	V	
Current through input pin (DC)	I_{IN}	±5.0	mA	
Current through status pin (DC)	I_{ST}	±5.0		
see internal circuit diagrams page 6...				
Thermal resistance	chip - case: junction - ambient (free air): SMD version, device on pcb ⁴⁾ :	R_{thJC} R_{thJA}	≤ 1 ≤ 75 ≤ tbd	K/W

3) V_S is setup without DUT connected to the generator per ISO 7637-1 and DIN 40839

4) Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper area for V_{bb} connection. PCB is vertical without blown air.

Electrical Characteristics

Parameter and Conditions at $T_j = 25\text{ °C}$, $V_{bb} = 12\text{ V}$ unless otherwise specified	Symbol	Values			Unit
		min	typ	max	

Load Switching Capabilities and Characteristics

On-state resistance (pin 3 to 5) $I_L = 2\text{ A}$ $T_j = 25\text{ °C}$: $T_j = 150\text{ °C}$:	R_{ON}	--	30 55	38 70	$m\Omega$
Nominal load current (pin 3 to 5) ISO Proposal: $V_{ON} = 0.5\text{ V}$, $T_C = 85\text{ °C}$	$I_{L(ISO)}$	9	11	--	A
Output current (pin 5) while GND disconnected or GND pulled up, $V_{IN} = 0$, see diagram page 7, $T_j = -40\dots+150\text{ °C}$	$I_{L(GNDhigh)}$	--	--	1	mA
Turn-on time to 90% V_{OUT} : Turn-off time to 10% V_{OUT} : $R_L = 12\ \Omega$, $T_j = -40\dots+150\text{ °C}$	t_{on} t_{off}	50 10	160 --	300 80	μs
Slew rate on 10 to 30% V_{OUT} , $R_L = 12\ \Omega$, $T_j = -40\dots+150\text{ °C}$	dV/dt_{on}	0.4	--	2.5	$V/\mu\text{s}$
Slew rate off 70 to 40% V_{OUT} , $R_L = 12\ \Omega$, $T_j = -40\dots+150\text{ °C}$	$-dV/dt_{off}$	1	--	5	$V/\mu\text{s}$

Operating Parameters

Operating voltage ⁵⁾ $T_j = -40\dots+150\text{ °C}$:	$V_{bb(on)}$	4.5	--	42	V
Undervoltage shutdown $T_j = -40\dots+150\text{ °C}$:	$V_{bb(under)}$	2.4	--	4.5	V
Undervoltage restart $T_j = -40\dots+150\text{ °C}$:	$V_{bb(u\ rst)}$	--	--	4.5	V
Undervoltage restart of charge pump see diagram page 12 $T_j = -40\dots+150\text{ °C}$:	$V_{bb(ucp)}$	--	6.5	7.5	V
Undervoltage hysteresis $\Delta V_{bb(under)} = V_{bb(u\ rst)} - V_{bb(under)}$	$\Delta V_{bb(under)}$	--	0.2	--	V
Overvoltage shutdown $T_j = -40\dots+150\text{ °C}$:	$V_{bb(over)}$	42	--	52	V
Overvoltage restart $T_j = -40\dots+150\text{ °C}$:	$V_{bb(o\ rst)}$	42	--	--	V
Overvoltage hysteresis $T_j = -40\dots+150\text{ °C}$:	$\Delta V_{bb(over)}$	--	0.2	--	V
Overvoltage protection ⁶⁾ $I_{bb} = 40\text{ mA}$ $T_j = -40\text{ °C}$: $T_j = 25\dots+150\text{ °C}$:	$V_{bb(AZ)}$	60 63	-- 67	--	V
Standby current (pin 3) $V_{IN} = 0$, $I_{ST} = 0$, $T_j = -40\dots+25\text{ °C}$: $T_j = 150\text{ °C}$:	$I_{bb(off)}$	-- --	12 18	25 60	μA
Leakage output current (included in $I_{bb(off)}$) $V_{IN} = 0$	$I_{L(off)}$	--	6	--	μA
Operating current (Pin 1) ⁷⁾ , $V_{IN} = 5\text{ V}$	I_{GND}	--	1.1	--	mA

⁵⁾ At supply voltage increase up to $V_{bb} = 6.5\text{ V}$ typ without charge pump, $V_{OUT} \approx V_{bb} - 2\text{ V}$

⁶⁾ see also $V_{ON(CL)}$ in table of protection functions and circuit diagram page 7. Measured without load.

Protection Functions

Initial peak short circuit current limit (pin 3 to 5) ⁸⁾ , (max 400 μ s if $V_{ON} > V_{ON(SC)}$)	$I_{L(SCp)}$				
$T_j = -40^\circ\text{C}$:		--	--	74	A
$T_j = 25^\circ\text{C}$:		--	44	--	
$T_j = +150^\circ\text{C}$:		24	--	--	
Repetitive short circuit current limit $T_j = T_{jt}$ (see timing diagrams, page 10)	$I_{L(SCr)}$	22	35	--	A
Short circuit shutdown delay after input pos. slope $V_{ON} > V_{ON(SC)}$, min value valid only, if input "low" time exceeds 30 μ s	$t_{d(SC)}$	80	--	400	μ s
Output clamp (inductive load switch off) at $V_{OUT} = V_{bb} - V_{ON(CL)}$, $I_L = 30$ mA	$V_{ON(CL)}$	--	58	--	V
Short circuit shutdown detection voltage (pin 3 to 5)	$V_{ON(SC)}$	--	8.3	--	V
Thermal overload trip temperature	T_{jt}	150	--	--	$^\circ\text{C}$
Thermal hysteresis	DT_{jt}	--	10	--	K
Inductive load switch-off energy dissipation ⁹⁾ , $T_{j\text{Start}} = 150^\circ\text{C}$, single pulse	E_{AS}	--	--	1.7	J
$V_{bb} = 12$ V:	E_{Load12}			1.3	
$V_{bb} = 24$ V:	E_{Load24}			1.0	
Reverse battery (pin 3 to 1) ¹⁰⁾	$-V_{bb}$	--	--	32	V
Integrated resistor in V_{bb} line	R_{bb}	--	120	--	Ω

Diagnostic Characteristics

Open load detection current (on-condition)	$T_j = -40^\circ\text{C}$: $T_j = 25..150^\circ\text{C}$:	$I_L(OL)$	2 2	-- --	900 750	mA
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7) Add I_{ST} , if $I_{ST} > 0$, add I_{IN} , if $V_{IN} > 5.5$ V



8) Short circuit current limit for max. duration of 400 μ s, prior to shutdown (see $t_{d(SC)}$ page 4)

9) While demagnetizing load inductance, dissipated energy in PROFET is $E_{AS} = \int V_{ON(CL)} \cdot i_L(t) dt$, approx.

$$E_{AS} = \frac{1}{2} \cdot L \cdot I_L^2 \cdot \left(\frac{V_{ON(CL)}}{V_{ON(CL)} - V_{bb}} \right), \text{ see diagram page 8}$$

10) Reverse load current (through intrinsic drain-source diode) is normally limited by the connected load. Reverse current I_{GND} of ≈ 0.3 A at $V_{bb} = -32$ V through the logic heats up the device. Time allowed under these condition is dependent on the size of the heatsink. Reverse I_{GND} can be reduced by an additional external GND-resistor (150 Ω). Input and Status currents have to be limited (see max. ratings page 2 and circuit page 7).

Input and Status Feedback¹¹⁾

Input turn-on threshold voltage		$V_{IN(T+)}$	1.5	--	2.4	V
Input turn-off threshold voltage		$V_{IN(T-)}$	1.0	--	--	V
Input threshold hysteresis		$\Delta V_{IN(T)}$	--	0.5	--	V
Off state input current (pin 2)	$V_{IN} = 0.4 \text{ V}$:	$I_{IN(off)}$	1	--	30	μA
On state input current (pin 2)	$V_{IN} = 3.5 \text{ V}$:	$I_{IN(on)}$	10	25	50	μA
Status invalid after positive input slope (short circuit)	$T_j = -40 \dots +150^\circ\text{C}$:	$t_{d(ST\ SC)}$	80	200	400	μs
Status invalid after positive input slope (open load)	$T_j = -40 \dots +150^\circ\text{C}$:	$t_{d(ST)}$	350	--	1600	μs
Status output (CMOS)	$T_j = -40 \dots +150^\circ\text{C}$, $I_{ST} = -50 \mu\text{A}$:	$V_{ST(high)}^{12)}$	4.4	5.1	6.5	V
	$T_j = -40 \dots +150^\circ\text{C}$, $I_{ST} = +1.6 \text{ mA}$:	$V_{ST(low)}$	--	--	0.4	
Max. status current for valid status output,	current source (out):	$-I_{ST}$	--	--	0.25	mA
$T_j = -40 \dots +150^\circ\text{C}$	current sink (in) :	$+I_{ST}^{13)}$	--	--	1.6	

11) If a ground resistor R_{GND} is used, add the voltage drop across this resistor.

12) $V_{St\ high} \approx V_{bb}$ during undervoltage shutdown

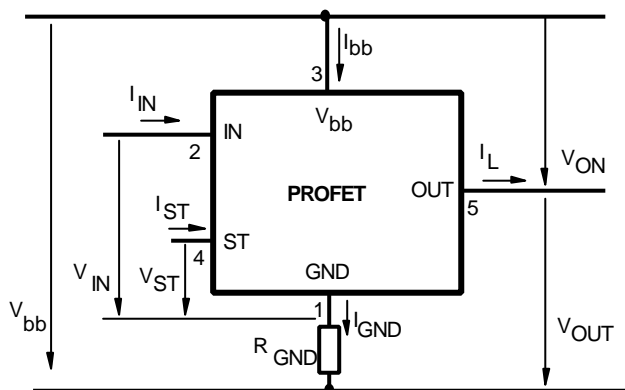
13) No current sink capability during undervoltage shutdown

Truth Table

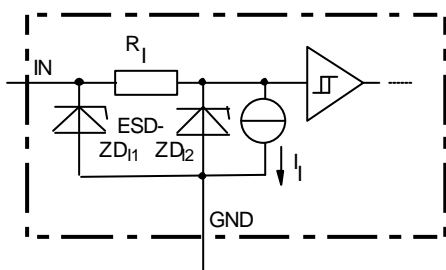
	Input-level	Output level	Status		
			432 D2	432 E2/F2	432 I2
Normal operation	L	L	H	H	H
	H	H	H	H	H
Open load	L	14)	H	H	L
	H	H	L	L	H
Short circuit to GND	L	L	H	H	H
	H	L	L	L	L
Short circuit to V _{bb}	L	H	H	H	L
	H	H	H (L ¹⁵)	H (L ¹⁵)	H
Overtemperature	L	L	L	L	L
	H	L	L	L	L
Undervoltage	L	L	L ¹⁶⁾	H	L ¹⁶⁾
	H	L	L ¹⁶⁾	H	L ¹⁶⁾
Overvoltage	L	L	L	H	L
	H	L	L	H	L

L = "Low" Level
H = "High" Level

Terms

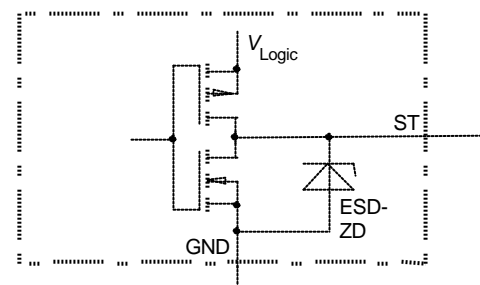


Input circuit (ESD protection)



ZD1 6.1 V typ., ESD zener diodes are not designed for continuous current

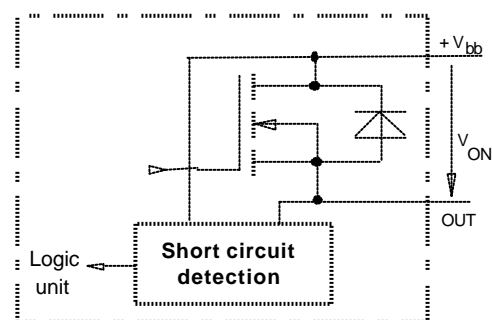
Status output



Zener diode: 6.1 V typ., max 5 mA, V_{Logic} 5 V typ, ESD zener diodes are not designed for continuous current

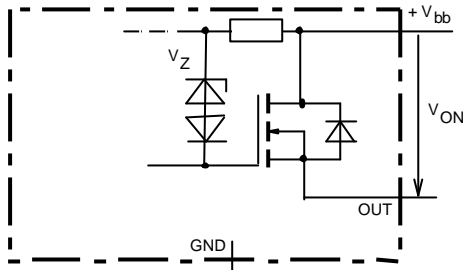
Short Circuit detection

Fault Condition: V_{ON} > 8.3 V typ.; IN high



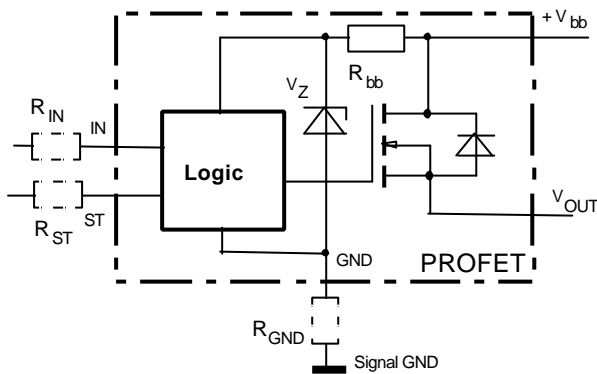
- 14) Power Transistor off, high impedance
- 15) Low resistance short V_{bb} to output may be detected by no-load-detection
- 16) No current sink capability during undervoltage shutdown

Inductive and overvoltage output clamp



V_{ON} clamped to 58 V typ.

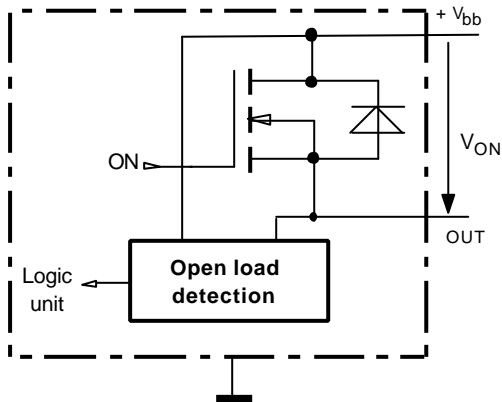
Overvolt. and reverse batt. protection



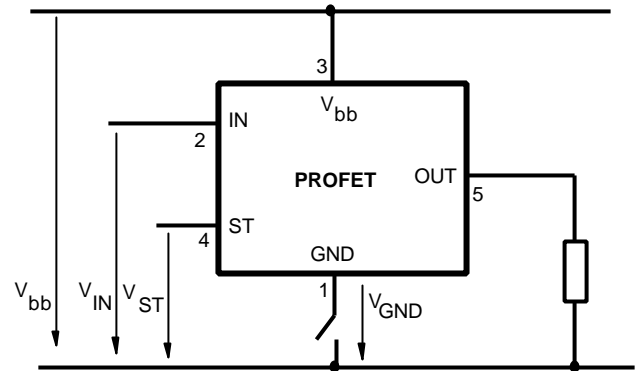
$R_{bb} = 120 \Omega$ typ., $V_Z + R_{bb} * 40 \text{ mA} = 67 \text{ V}$ typ., add R_{GND} , R_{IN} , R_{ST} for extended protection

Open-load detection

ON-state diagnostic condition: $V_{ON} < R_{ON} * I_{L(OL)}$; IN high

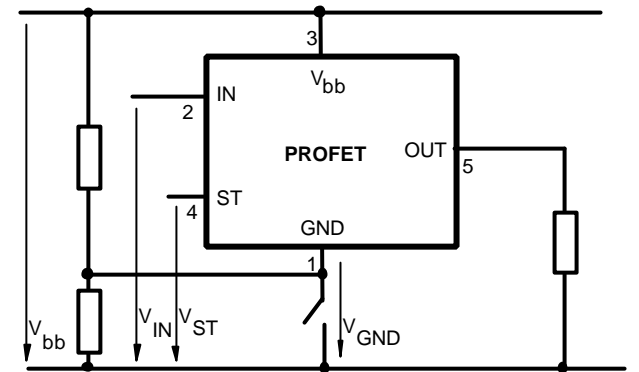


GND disconnect



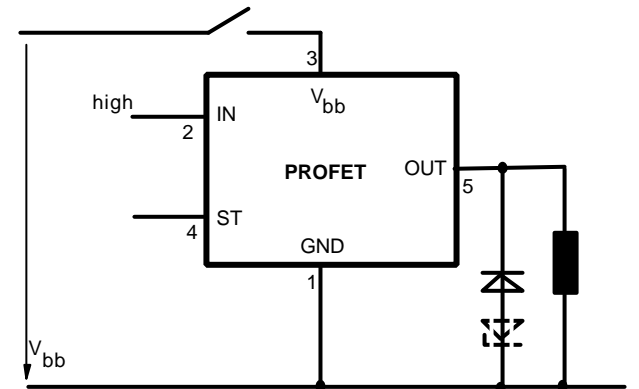
Any kind of load. In case of Input=high is $V_{OUT} \approx V_{IN} - V_{IN(T+)}$. Due to $V_{GND} > 0$, no $V_{ST} = \text{low}$ signal available.

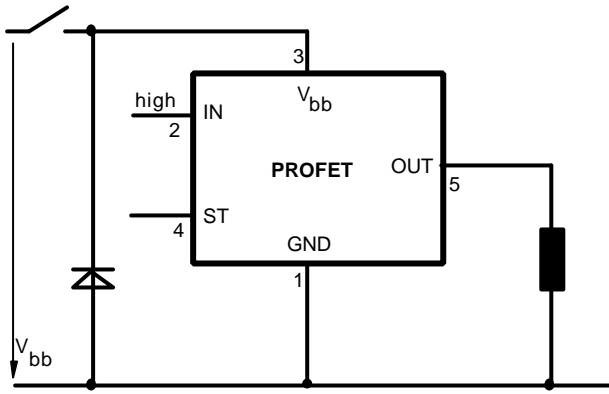
GND disconnect with GND pull up



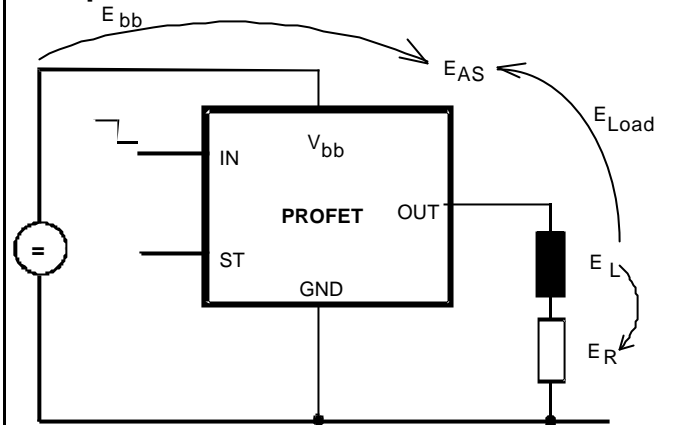
Any kind of load. If $V_{GND} > V_{IN} - V_{IN(T+)}$ device stays off. Due to $V_{GND} > 0$, no $V_{ST} = \text{low}$ signal available.

Vbb disconnect with charged inductive load





Inductive Load switch-off energy dissipation



Energy dissipated in PROFET $E_{AS} = E_{bb} + E_L - E_R$.
 $E_{Load} < E_L$, $E_L = \frac{1}{2} * L * I_L^2$

Options Overview

all versions: High-side switch, Input protection, ESD protection, load dump and reverse battery protection , protection against loss of ground

Type	BTS	432D2	432E2	432F2	432I2
Logic version		D	E	F	I
Overtemperature protection $T_j > 150\text{ °C}$, latch function ¹⁷⁾¹⁸⁾ $T_j > 150\text{ °C}$, with auto-restart on cooling		X		X	X
Short-circuit to GND protection switches off when $V_{ON} > 8.3\text{ V typ.}$ ¹⁷⁾ (when first turned on after approx. 200 μs)		X	X	X	X
Open load detection in OFF-state with sensing current 30 $\mu\text{A typ.}$ in ON-state with sensing voltage drop across power transistor		X	X	X	X
Undervoltage shutdown with auto restart		X	X	X	X
Overvoltage shutdown with auto restart		X	X	X	X
Status feedback for					
overtemperature		X	X	X	X
short circuit to GND		X	X	X	X
short to V_{bb}		_19)	_19)	_19)	X
open load		X	X	X	X
undervoltage		X	-	-	X
overvoltage		X	-	-	X
Status output type					
CMOS		X			X
Open drain			X	X	
Output negative voltage transient limit (fast inductive load switch off) to $V_{bb} - V_{ON(CL)}$		X	X	X	X
Load current limit					
high level (can handle loads with high inrush currents)		X	X		
medium level					X
low level (better protection of application)				X	

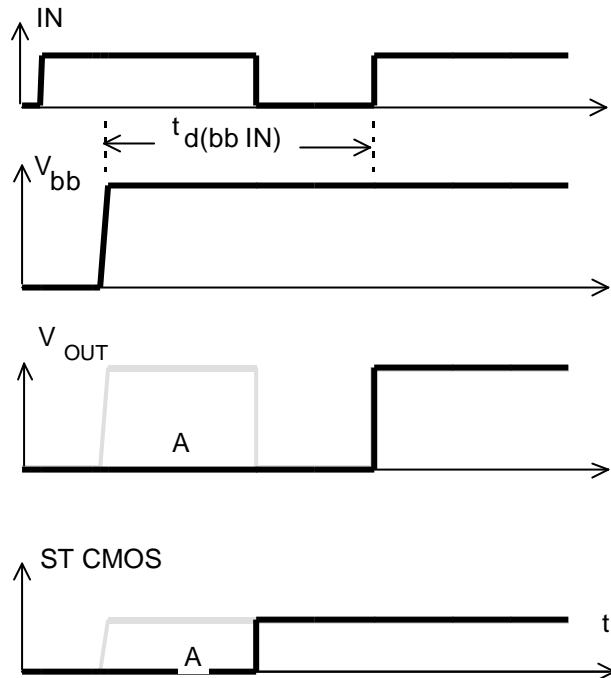
¹⁷⁾ Latch except when $V_{bb} - V_{OUT} < V_{ON(SC)}$ after shutdown. In most cases $V_{OUT} = 0\text{ V}$ after shutdown ($V_{OUT} \neq 0\text{ V}$ only if forced externally). So the device remains latched unless $V_{bb} < V_{ON(SC)}$ (see page 4). No latch between turn on and $t_{d(SC)}$.

¹⁸⁾ With latch function. Reseted by a) Input low, b) Undervoltage, c) Overvoltage

¹⁹⁾ Low resistance short V_{bb} to output may be detected by no-load-detection

Timing diagrams

Figure 1a: V_{bb} turn on:



in case of too early V_{IN} =high the device may not turn on (curve A)

$t_{d(bb\ IN)}$ approx. 150 μ s

Figure 2a: Switching a lamp,

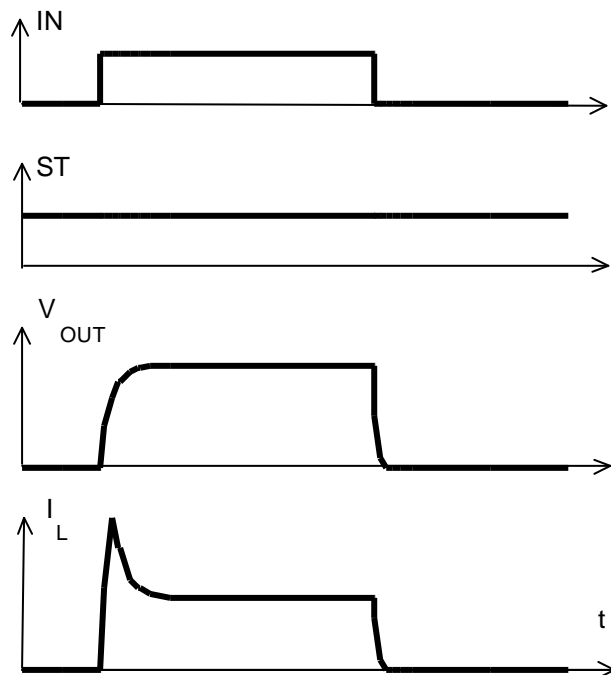
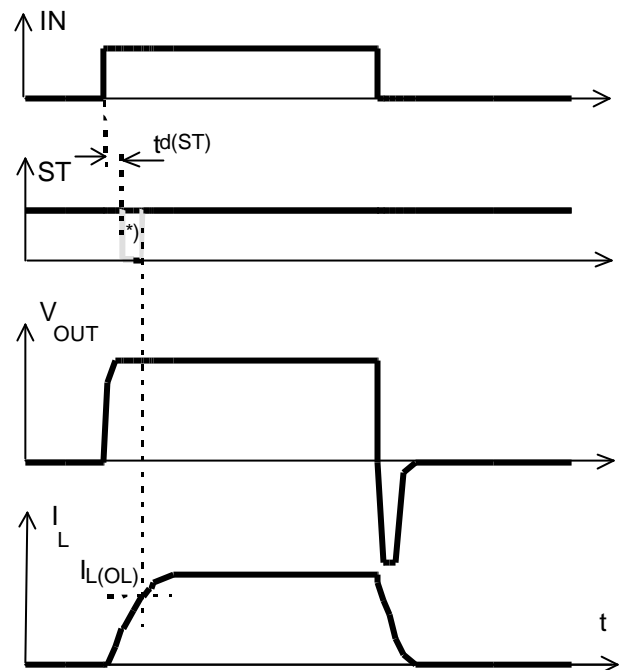
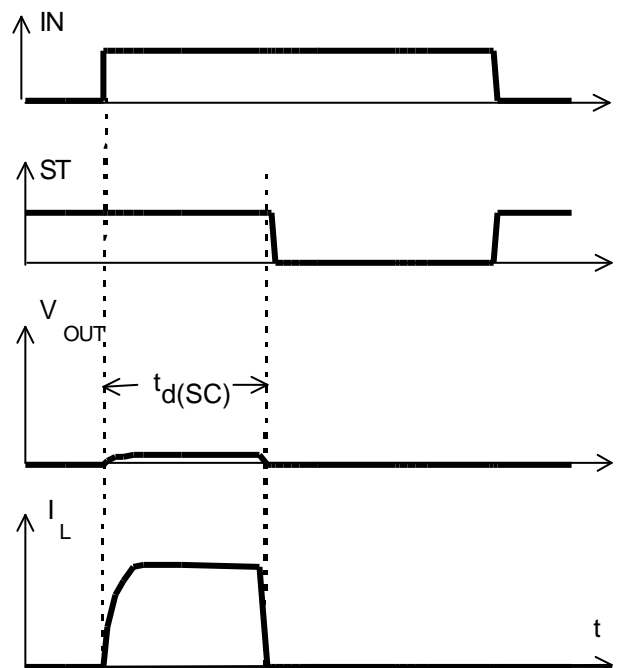


Figure 2b: Switching an inductive load

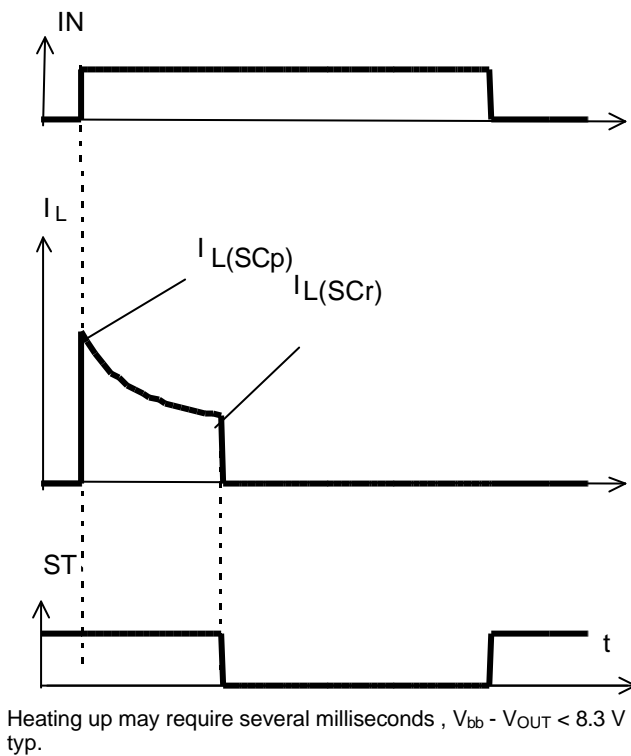
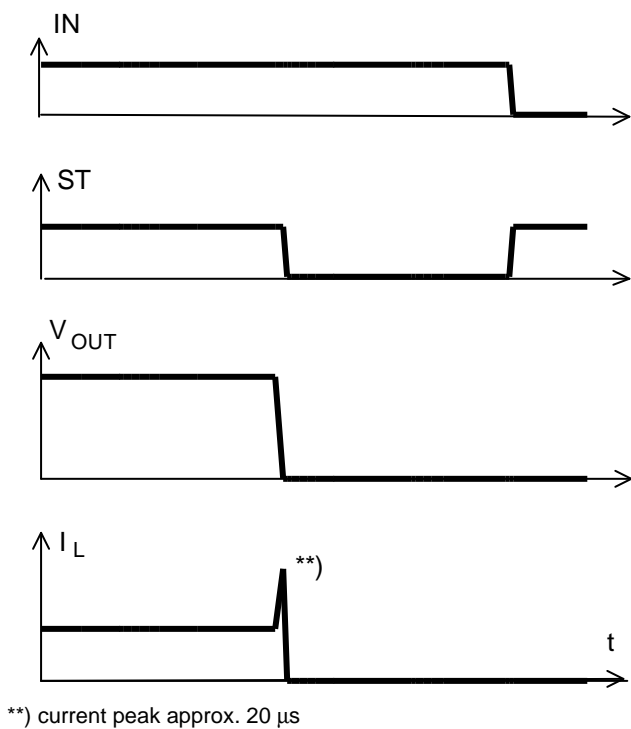


*) if the time constant of load is too large, open-load-status may occur

Figure 3a: Turn on into short circuit,



$t_{d(SC)}$ approx. 200 μ s if $V_{bb} - V_{OUT} > 8.3$ V typ.

Figure 3b: Turn on into overload,

Figure 3c: Short circuit while on:

Figure 4a: Overtemperature,

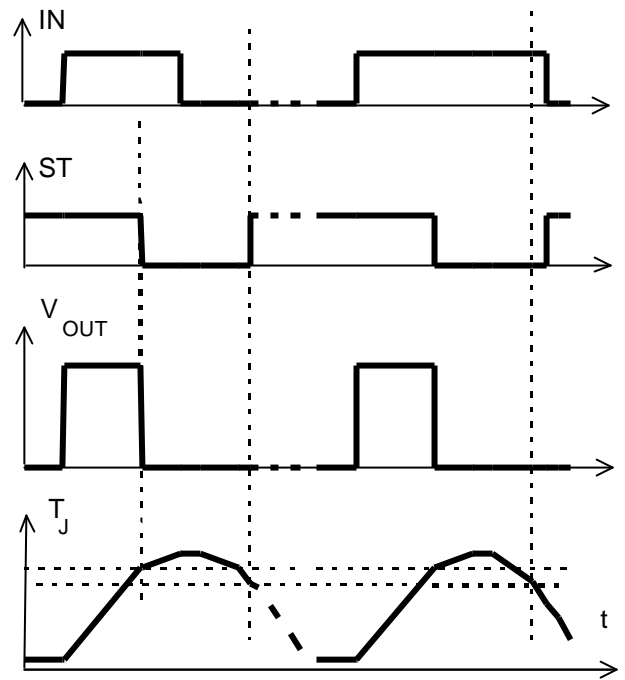
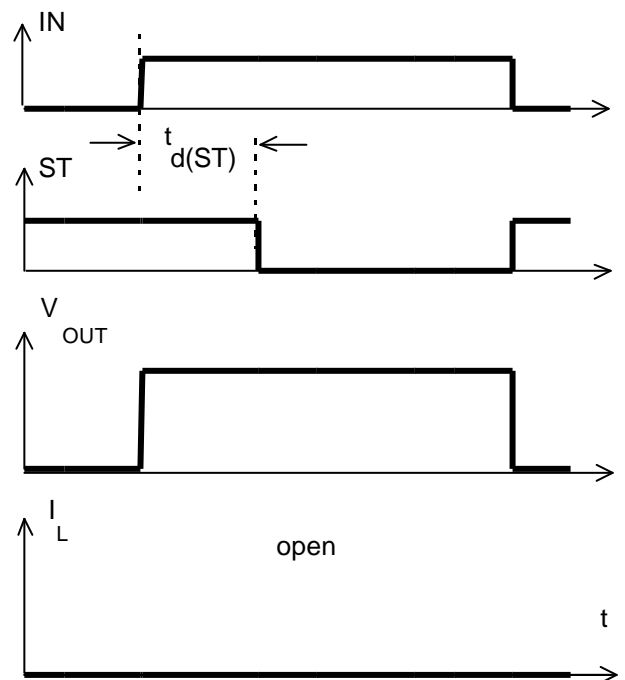
 Reset if (IN=low) and ($T_j < T_{jt}$)

Figure 5a: Open load: detection in ON-state, turn on/off to open load


Figure 5b: Open load: detection in ON-state, open load occurs in on-state

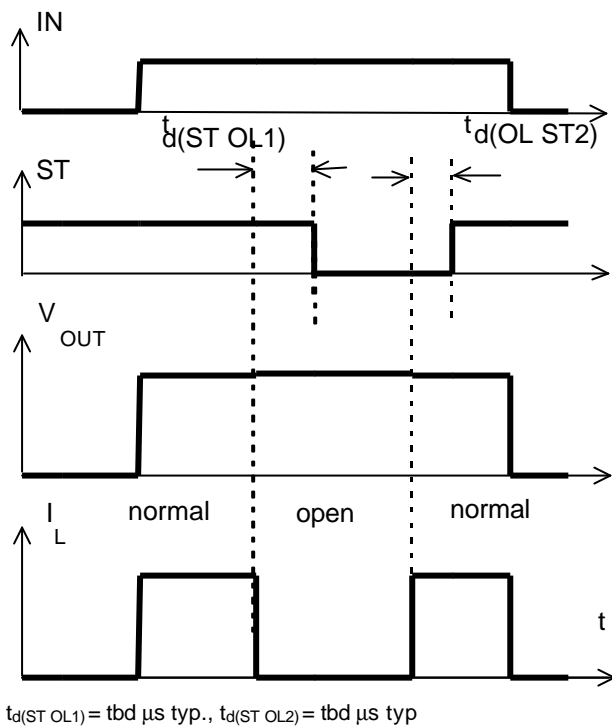


Figure 6b: Undervoltage restart of charge pump

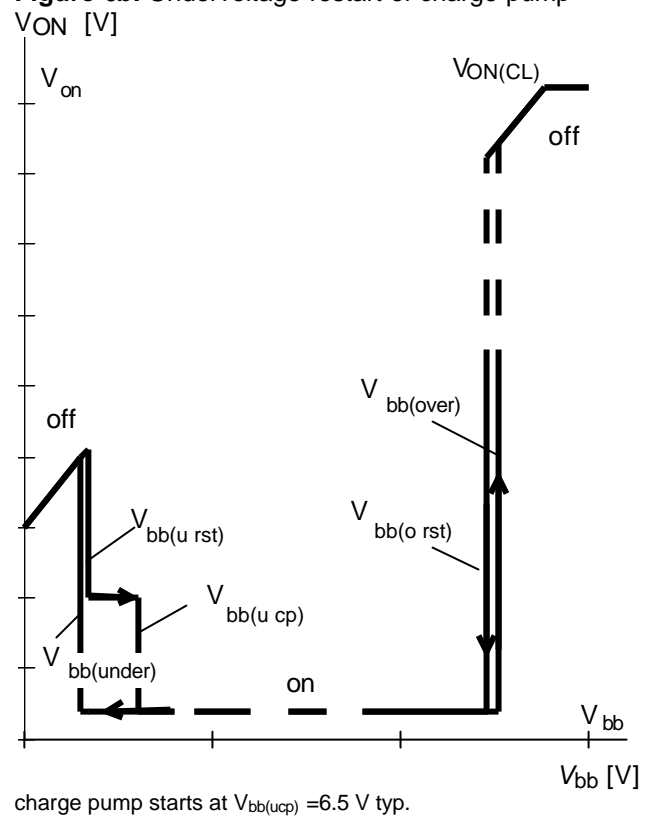


Figure 6a: Undervoltage:

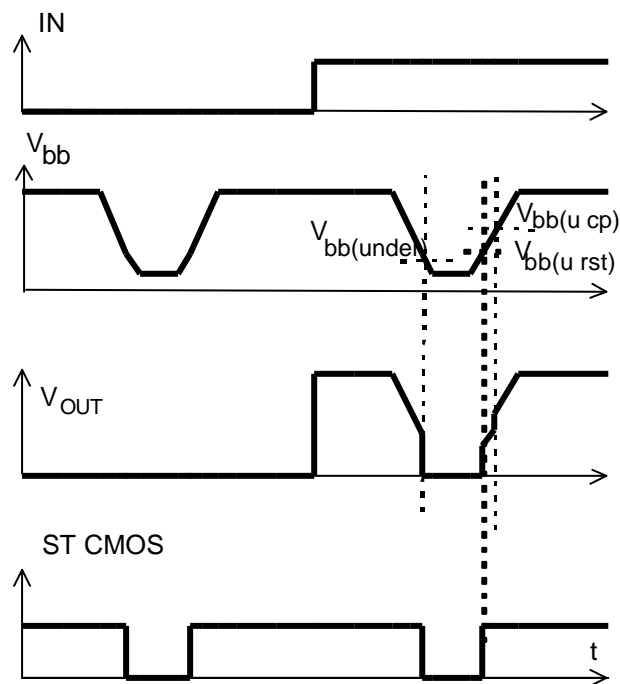
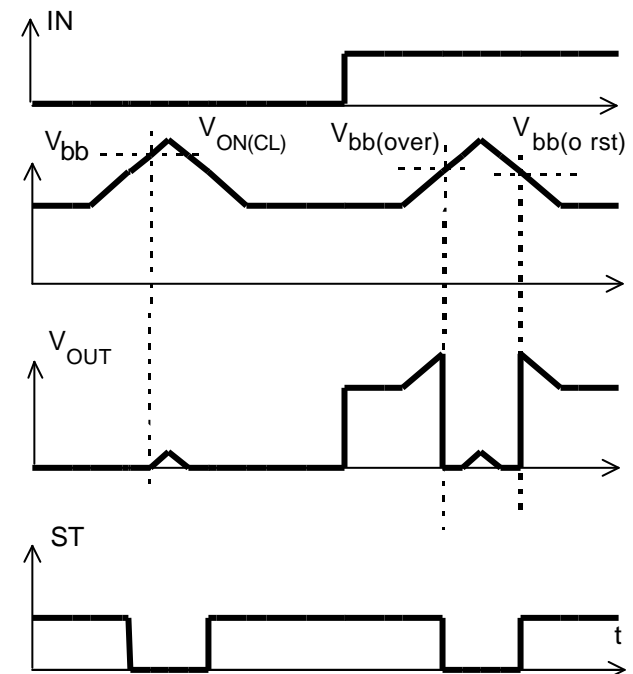


Figure 7a: Overvoltage:



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